

### DESCRIPTION

The IS280-4 quad channel optocoupler each channel consist of two infrared emitting diodes in reverse parallel connection optically coupled to an NPN silicon photo transistor.

This device belongs to Isocom Compact Range of Optocouplers.

### FEATURES

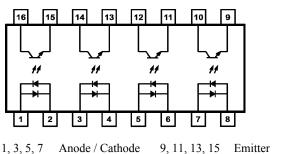
- Half Pitch 1.27mm
- High AC Isolation voltage 3750V<sub>RMS</sub>
- Wide Operating Temperature Range -55°C to 110°C
- Pb Free and RoHS Compliant
- UL Approval E91231 Model "AHP"

## APPLICATIONS

- Hybrid Substrates with High Density Mounting
- Industrial System Controllers
- Measuring Instruments
- System Appliances

#### **ORDER INFORMATION**

 Available in Tape and Reel IS280-4 : 2000pcs per reel



2, 4, 6, 8 Cathode / Anode 10, 12, 14, 16 Collector

#### ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C)

Stresses exceeding the absolute maximum ratings can cause permanent damage to the device. Exposure to absolute maximum ratings for long periods of time can adversely affect reliability.

#### Input

Forward Current	±50mA
Power dissipation	65mW

#### Output

Collector to Emitter Voltage BV <sub>CEO</sub>	80V
Emitter to Collector Voltage BV <sub>ECO</sub>	7V
Collector Current	50mA
Junction Temperature	125°C
Power Dissipation	100mW

#### Total Package

Isolation Voltage	$3750V_{RMS}$
Total Power Dissipation	170mW
Operating Temperature	-55 to 110 °C
Storage Temperature	-55 to 150 °C
Lead Soldering Temperature (10s)	260°C

#### ISOCOM COMPONENTS 2004 LTD

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## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise specified)

#### INPUT

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Forward Voltage	$\mathbf{V}_{\mathrm{F}}$	$I_F = \pm 20 mA$		1.2	1.4	V
Terminal Capacitance	C <sub>IN</sub>	V = 0V, f = 1KHz		60		pF

#### OUTPUT

Parameter	Symbol	Test Condition	Min	Тур.	Мах	Unit
Collector-Emitter Breakdown Voltage	BV <sub>CEO</sub>	$I_{\rm C} = 0.1 {\rm mA},  I_{\rm F} = 0 {\rm mA}$	80			V
Emitter-Collector Breakdown Voltage	BV <sub>ECO</sub>	$I_E = 10 \mu A$ , $I_F = 0 m A$	7			V
Collector-Emitter Dark Current	I <sub>CEO</sub>	$V_{CE} = 20V, I_F = 0mA$			100	nA

#### COUPLED

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Current transfer ratio	CTR	$I_F = \pm 1 \text{mA}, V_{CE} = 5 \text{V}$	20		400	%
Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	$I_{\rm F} = \pm 8 {\rm mA}, I_{\rm C} = 2.4 {\rm mA}$			0.4	V
Floating Capacitance	$C_{\rm f}$	$V_F = 0V, f = 1MHz$		0.8	1	pF
Output Rise Time	t <sub>r</sub>	$V_{CE} = 2V$ Ic = $\pm 2mA$		3	18	μs
Output Fall Time	t <sub>f</sub>	$R_{\rm L} = 100\Omega$		4	18	

#### ISOLATION

Parameter	Symbol	Test Condition	Min	Тур.	Max	Unit
Isolation Voltage	V <sub>ISO</sub>	R.H. = 40% to 60%, t = 1 min Note 1	3750			V <sub>RMS</sub>
Input - Output Resistance	R <sub>I-O</sub>	$V_{LO} = 500VDC$ R.H. = 40% to 60% Note 1	5x10 <sup>10</sup>	1x10 <sup>11</sup>		Ω

Note 1 : Measured with input leads shorted together and output leads shorted together.



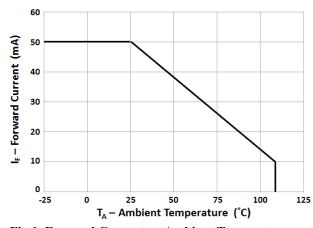


Fig 1 Forward Current vs Ambient Temperature

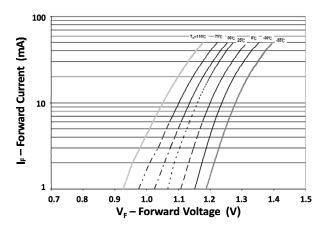
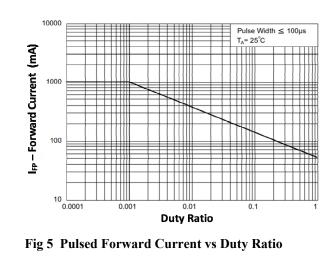
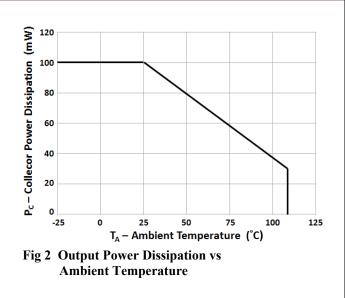


Fig 3 Forward Current vs Forward Voltage





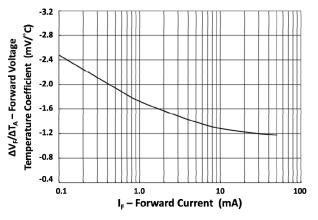


Fig 4 Forward Voltage Temperature Coefficient vs Forward Current

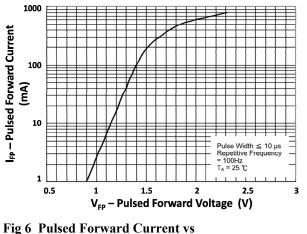


Fig 6 Pulsed Forward Current vs Pulsed Forward Voltage



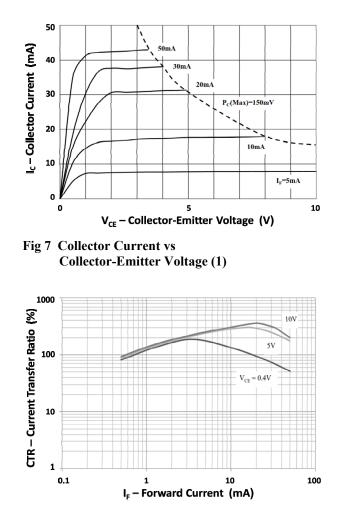
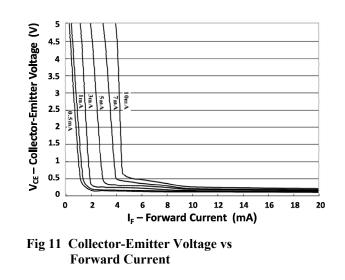
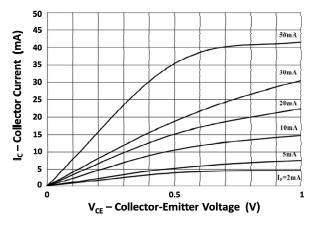
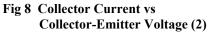


Fig 9 Current Transfer Ratio vs Forward Current







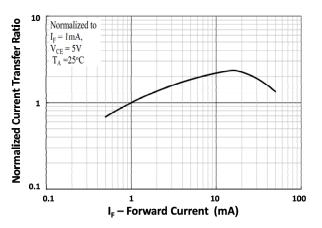
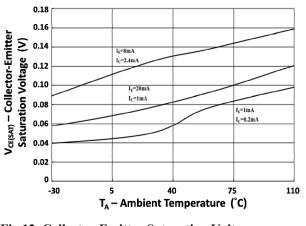
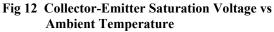


Fig 10 Normalized Current Transfer Ratio vs Forward Current







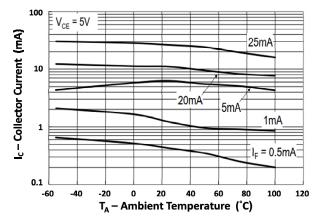


Fig 13 Collector Current vs Ambient Temperature

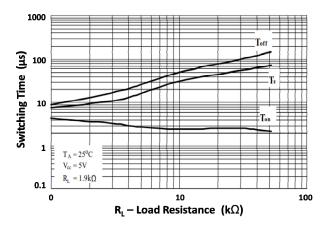
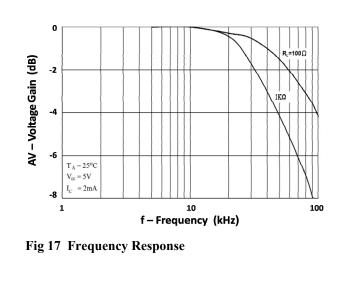
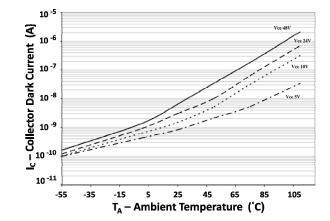
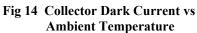


Fig 15 Switching Time vs Load Resistance







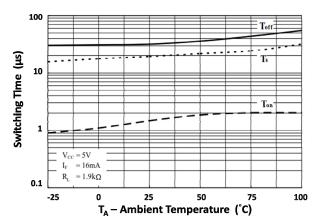
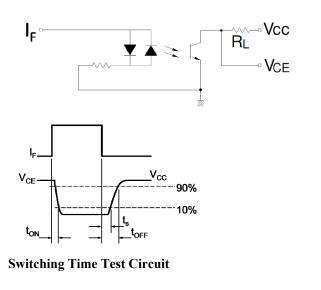


Fig 16 Switching Time vs Ambient Temperature

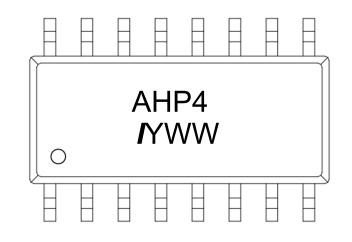




### **ORDER INFORMATION**

	IS280-4				
After PN PN Description Packing quantity					
None	IS280-4	Surface Mount Tape & Reel	2000 pcs per reel		

#### **DEVICE MARKING**



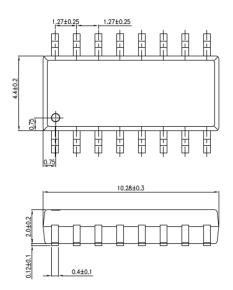
AHP4	denotes IS280-4
I	denotes Isocom

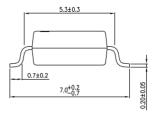
Y denotes 1 digit Year code

WW denotes 2 digit Week code

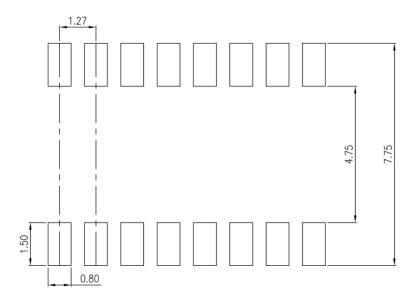


## PACKAGE DIMENSIONS (mm)



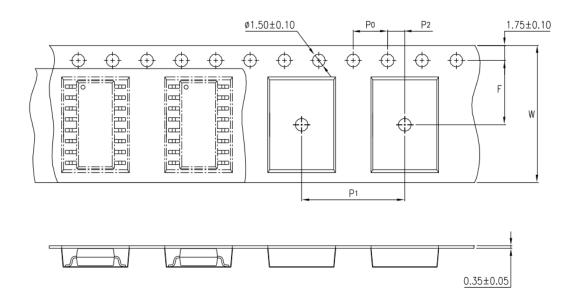


## **RECOMMENDED SOLDER PAD LAYOUT (mm)**

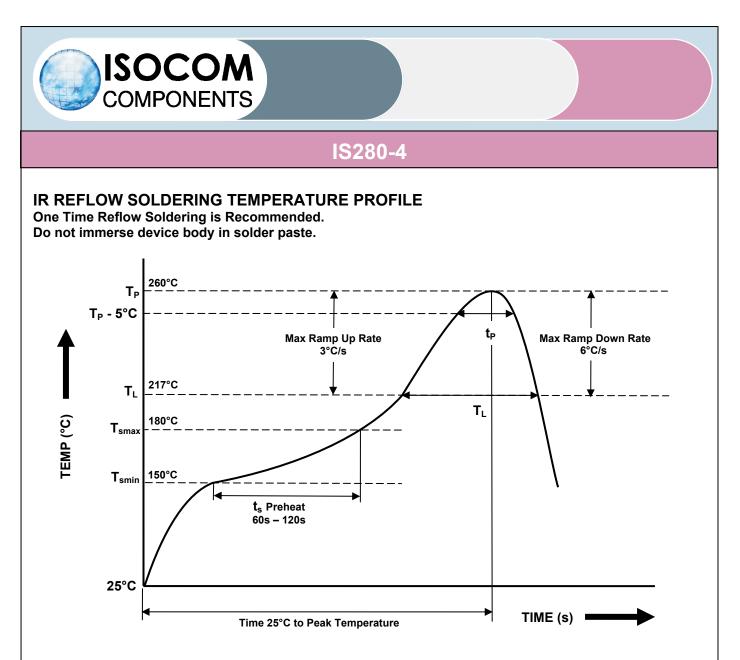




### TAPE AND REEL PACKAGING



Description	Dimension	mm (inch)
Tape Width	W	16 ± 0.3 (0.63)
Pitch of Sprocket Holes	P0	4 ± 0.1 (0.15)
	F	7.5 ± 0.1 (0.295)
Distance of Compartment	P2	2 ± 0.1 (0.79)
Distance of Compartment to Compartment	P1	12 ± 0.1 (0.472)



Profile Details	Conditions
Preheat - Min Temperature (T <sub>SMIN</sub> ) - Max Temperature (T <sub>SMAX</sub> ) - Time T <sub>SMIN</sub> to T <sub>SMAX</sub> (t <sub>s</sub> )	150°C 180°C 60s - 120s
	260°C 217°C 20s 60s 3°C/s max 3 - 6°C/s
Average Ramp Up Rate ( $T_{smax}$ to $T_P$ )	3°C/s max
Time 25°C to Peak Temperature	8 minutes max



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